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PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

*MAY 19 2003*  
*PATENT & TRADEMARK*

Applicant: George Hsieh  
Serial No.: 09/897320  
Filed: June 29, 2001  
Title: ELECTRONIC ASSEMBLY WITH SOLDERABLE HEAT SINK AND  
METHODS OF MANUFACTURE

Examiner: Gregory Thompson  
Group Art Unit: 2835  
Docket No.: 884.462US1

**AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Applicant has reviewed the Office Action mailed on January 16, 2003. Please amend the above-identified patent application as follows. The amendments are made in the "revised amendment format" announced by the Deputy Commissioner for Patent Examination Policy on January 31, 2003.

This response is accompanied by a Petition, as well as the appropriate fee, to obtain a one-month extension of the period for responding to the Office action, thereby moving the deadline for response from April 16, 2003 to May 16, 2003.

TECHNOLOGY CENTER 2230  
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